#### 505501232 05/30/2019

### PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5548036

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
JENNY SHIO YIN ONG	08/09/2018
SEOK LING LIM	08/13/2018
BOK ENG CHEAH	08/09/2018
JACKSON CHUNG PENG KONG	08/13/2018
CHIN LEE KUAN	08/14/2018

#### RECEIVING PARTY DATA

Name:	INTEL CORPORATION	
Street Address:	2200 MISSION COLLEGE BLVD.	
City:	SANTA CLARA	
State/Country:	CALIFORNIA	
Postal Code:	95054	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16017719

#### **CORRESPONDENCE DATA**

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 612-373-6900 **Email:** request@slwip.com

Correspondent Name: SCHWEGMAN, LUNDBERG & WOESSNER/INTEL

Address Line 1: PO BOX 2938

Address Line 4: MINNEAPOLIS, MINNESOTA 55402

ATTORNEY DOCKET NUMBER:	1884.047US1	
NAME OF SUBMITTER:	NANCY CUNDALL	
SIGNATURE:	/Nancy Cundall/	
DATE SIGNED:	05/30/2019	

**Total Attachments: 3** 

source=1884047US1Assignment#page1.tif

PATENT REEL: 049323 FRAME: 0601

505501232

source=1884047US1Assignment#page2.tif source=1884047US1Assignment#page3.tif

PATENT REEL: 049323 FRAME: 0602

## RECORDATION FORM COVER SHEET PATENTS ONLY

Atty Ref/Docket No.: (P114967MY-US) 1884.047US1 Patent and Trademark Office

To the Director of the U.S. Patent and Trademark Office: Plea				
Name of conveying party(ies):	2. Name and address of receiving party(ies):			
	Name: Intel Corporation			
Jenny Shio Yin Ong, Seok Ling Lim, Bok Eng Cheah, Jackson Chung Peng Kong, Chin Lee Kuan	Street Address: 2200 Mission College Blvd.			
Additional name(s) of conveying party(ies) attached?	City: Santa Clara State: CA Zip: 95054 Country: United States of America			
[ ]Yes [X]No	Additional name(s) & address(es) attached? [ ]Yes [X]No			
3. Nature of conveyance:	reducional name(s) or address(es) actualizer. [11 es [11]110			
[X] Assignment [ ] Merger [ ] Security Agreement [ ] Change of Name [ ] Other				
Execution Date: <u>August 9, 2018, August 13, 2018, August 9, 2018, August 13, 2018, August 14, 2018</u>				
4. Application number(s) or patent number(s):				
If this document is being filed together with a new application.	the execution date of the application is:			
	••			
A. Patent Application No.(s)	B. Patent No.(s)			
Serial No. 16/017,719				
Additional numbers attached? [ ]Yes [X]No				
	6. Total number of applications and patents involved: 1			
5. Name and address of party to whom correspondence concerning document should be mailed:	7. Total fee (37 CFR 3.41):\$ <u>0.00</u>			
Name: John N. Greaves	[]Enclosed			
Address:	[]Authorized to be charged to deposit account			
Schwegman Lundberg & Woessner, P.A.	190743			
P.O. Box 2938 Minneapolis, Minnesota 55402	8. Please charge any additional fees or credit any over payments to our Deposit Account No.: 190743			
DO NOT USE THIS SPACE				
9. Statement and signature. To the best of my knowledge and belief, the foregoing informathe original document.	ation is true and correct and any attached copy is a true copy of  29. May 2019			
John N. Greaves/Reg. No. 40,362				
Name of Person Signing	Signature Date			
To	tal number of pages including cover sheet: 3			

Mail documents to be recorded with required cover sheet information to:

**Commissioner of Patents and Trademarks Mail Stop Assignment Recordation Services** P.O. Box 1450 Alexandria, VA 22313-1450

> **PATENT** REEL: 049323 FRAME: 0603

Intel Docket No.: P114967MY-US SLW Reference No.: (P114967MY-US) 1884.047US1

### <u>ASSIGNMENT</u>

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

<Jenny Shio Yin Ong, Seok Ling Lim, Bok Eng Cheah, Jackson Chung Peng Kong, Chin Lee Kuan>

hereby sell, assign, and transfer to:

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

# CAPACITORS EMBEDDED IN STIFFENERS FOR SMALL FORM-FACTOR AND METHODS OF ASSEMBLING SAME

(I hereby authorize and request any attorney having appropriate authority from the assignee to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on June 25, 2018 as

United States of America Application Number 16/017,719

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below.

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute

Page 1 of 2

Intel Docket No.: P114967MY-US SLW Reference No.: (P114967MY-US) 1884.047US1

all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful ouths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

- Royal	9th Aug 2018
Jenny Shio Yin Ong	Date Signed
Seok Ling Lim	13 August 2018
Stor Ling Lim	Date Signed
Bot by Chah.	9 August 2018
Bok Eng Cheah	Date Signed
John Co-j	13 August 2018
Jackson Chung Peng Kong	Date Signed
Huani	14 August 2018
Chin Lee Kuan	Date Signed